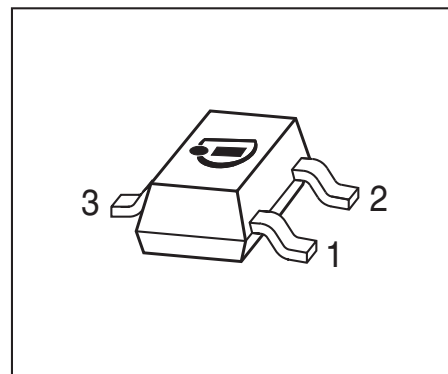


NPN Silicon RF Transistor

- For amplifier and oscillator applications in TV-tuners
- Pb-free (RoHS compliant) package



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Marking	Pin Configuration			Package
BF517	LRs	1 = B	2 = E	3 = C	SOT23

Maximum Ratings at $T_A = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	15	V
Collector-base voltage	V_{CBO}	25	
Emitter-base voltage	V_{EBO}	2.5	
Collector current	I_C	25	mA
Peak collector current	I_{CM}	50	
Total power dissipation $T_S \leq 55\text{ °C}$	P_{tot}	280	mW
Junction temperature	T_J	150	°C
Ambient temperature	T_A	-65 ... 150	
Storage temperature	T_{Stg}	-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R_{thJS}	≤ 340	K/W

¹⁾For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

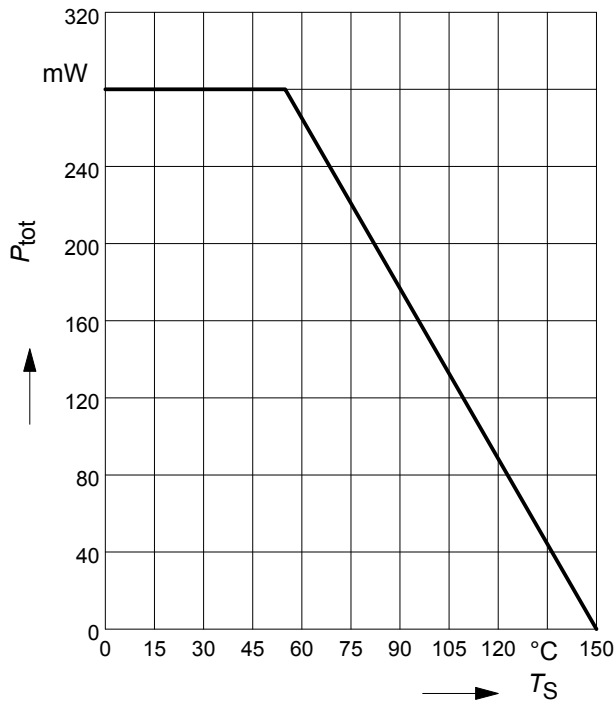
Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 1\text{ mA}$, $I_B = 0$	$V_{(BR)CEO}$	15	-	-	V
Collector-base cutoff current $V_{CB} = 10\text{ V}$, $I_E = 0$ $V_{CB} = 25\text{ V}$, $I_E = 0$	I_{CBO}	- -	- -	0.05 10	μA
Emitter-base cutoff current $V_{EB} = 2.5\text{ V}$, $I_C = 0$	I_{EBO}	-	-	100	nA
DC current gain $I_C = 2\text{ mA}$, $V_{CE} = 1\text{ V}$, pulse measured $I_C = 25\text{ mA}$, $V_{CE} = 1\text{ V}$, pulse measured	h_{FE}	40 20	- 70	150 -	-
Collector-emitter saturation voltage $I_C = 10\text{ mA}$, $I_B = 1\text{ mA}$	V_{CEsat}	-	0.1	0.4	V

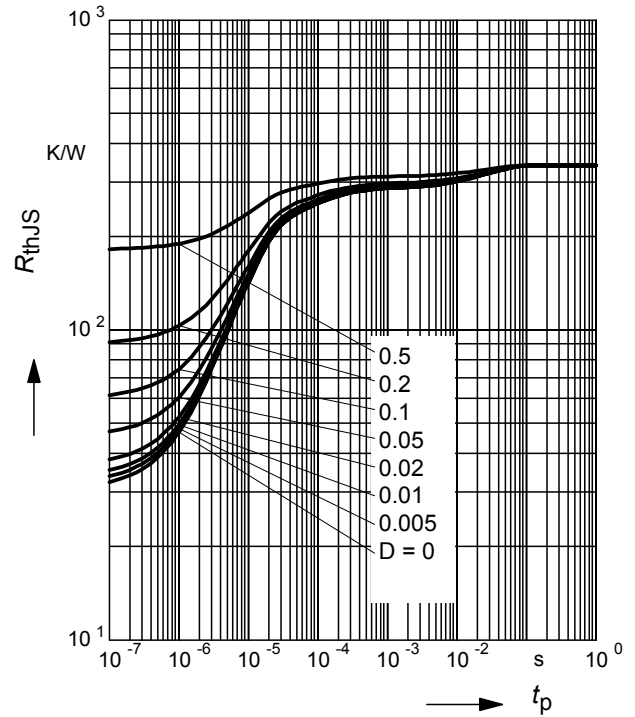
Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency $I_C = 2\text{ mA}$, $V_{CE} = 5\text{ V}$, $f = 200\text{ MHz}$ $I_C = 25\text{ mA}$, $V_{CE} = 5\text{ V}$, $f = 200\text{ MHz}$	f_T	1 1.3	1.4 2.5	- -	GHz
Collector-base capacitance $V_{CB} = 5\text{ V}$, $f = 1\text{ MHz}$, $V_{BE} = 0$, emitter grounded	C_{cb}	-	0.55	0.8	pF
Collector emitter capacitance $V_{CE} = 5\text{ V}$, $f = 1\text{ MHz}$, $V_{BE} = 0$, base grounded	C_{ce}	-	0.27	-	
Emitter-base capacitance $V_{EB} = 0.5\text{ V}$, $f = 1\text{ MHz}$, $V_{CB} = 0$, collector grounded	C_{eb}	-	0.9	1.45	
Minimum noise figure $I_C = 2\text{ mA}$, $V_{CE} = 5\text{ V}$, $Z_S = 50\text{ }\Omega$, $f = 800\text{ MHz}$	NF_{min}	-	3.5	5	dB
Transducer gain $I_C = 20\text{ mA}$, $V_{CE} = 5\text{ V}$, $Z_S = Z_L = 50\Omega$, $f = 500\text{ MHz}$	$ S_{21e} ^2$	-	13	-	dB
Third order intercept point at output $V_{CE} = 5\text{ V}$, $I_C = 20\text{ mA}$, $f = 800\text{ MHz}$, $Z_S = Z_{Sopt}$, $Z_L = Z_{Lopt}$	IP_3	-	21.5	-	dBm
1dB compression point $I_C = 20\text{ mA}$, $V_{CE} = 5\text{ V}$, $Z_S = Z_L = 50\Omega$, $f = 800\text{ MHz}$	P_{-1dB}	-	10	-	-

Total power dissipation $P_{\text{tot}} = f(T_S)$

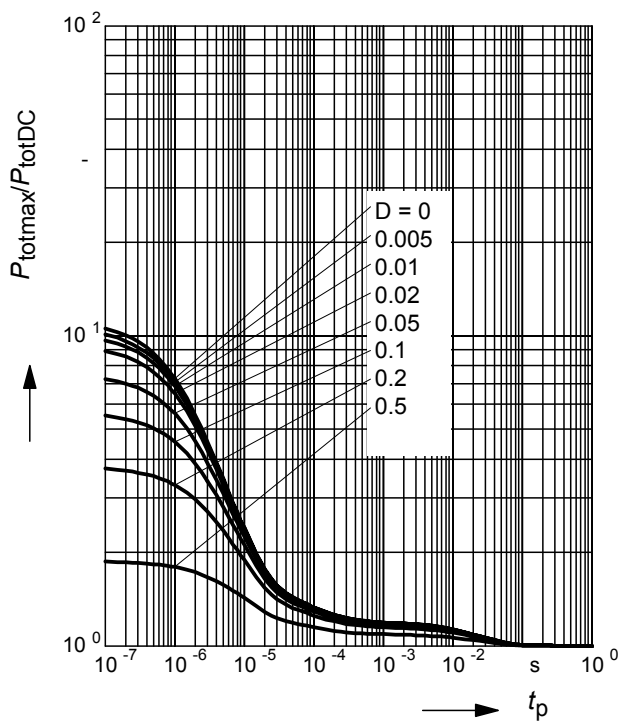


Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



Permissible Pulse Load

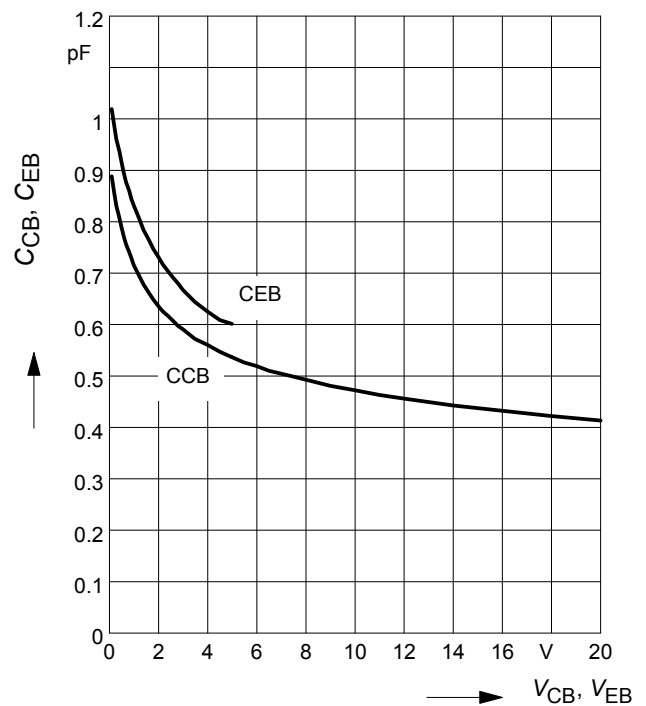
$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$



Collector-base capacitance $C_{\text{cb}} = f(V_{\text{CB}})$

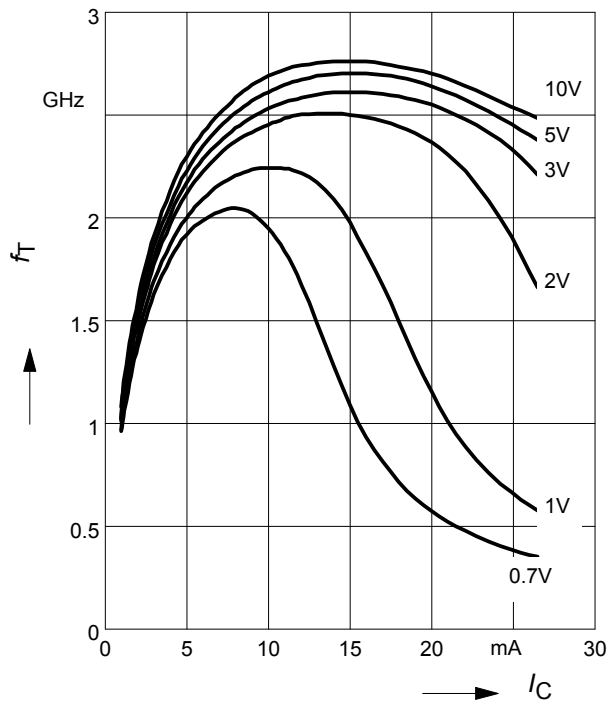
Emitter-base capacitance $C_{\text{eb}} = f(V_{\text{EB}})$

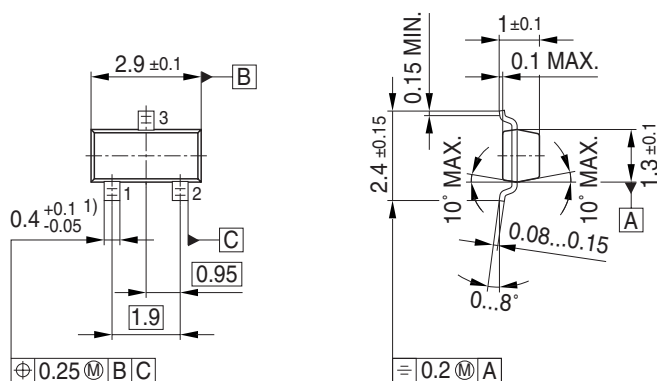
$f = 1 \text{ MHz}$



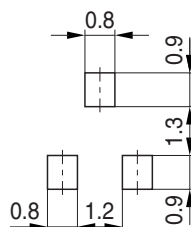
Transition frequency $f_T = f(I_C)$

V_{CE} = parameter





Foot Print



The diagram shows a top-down view of a BCW66 LED package. It is a rectangular component with four pins. The top pin is labeled 'Pin 1'. The package has a central rectangular area containing the text 'EHS' and '2005, June'. To the right of this area, the text 'Date code (YM)' is shown. Below the package, the text 'BCW66' and 'Type code' are shown. The Infineon logo is at the top right.

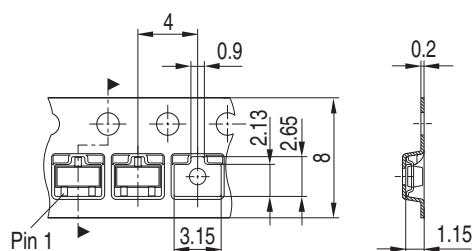
Infineon
Manufacturer

2005, June
Date code (YM)

Pin 1

BCW66
Type code

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



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